Overview

Today’s consumers generate and consume large volumes of data and video, exploding the required capacity and bandwidth for device memory. The Cadence® Denali® DDR family of high-speed interface IP connects to external memories with the necessary bandwidth for applications. The Cadence Denali High-Speed DDR PHY IP provides low latency and up to 3200Mbps throughput, while balancing power consumption and minimizing area.

Developed by experienced teams with industry-leading domain expertise and extensively validated with multiple hardware platforms, the DDR PHY IP is silicon proven and can provide customers with ease of integration and faster time to market. The DDR PHY IP is engineered to quickly and easily integrate into any system-on-chip (SoC), and is verified with the Denali DDR Controller IP as part of a complete memory subsystem solution.

The DDR PHY IP is designed to connect seamlessly and work with a third-party DFI-compliant memory controller. The DDR PHY IP is developed and validated to reduce risk for the customer, so that their system-on-chip (SoC) can be first time right. Developed for and available early in the lifecycle of the most advanced semiconductor process nodes, the DDR PHY IP is designed to be robust under varying noise conditions and to have interoperability with various supplier memory chips.

The DDR PHY IP is part of the comprehensive Cadence Design IP portfolio comprised of interface, Denali memory interface, analog, and systems and peripherals IP.

Key Features

- LPDDR4/LPDDR3/DDR4/DDR3 training with write-leveling and data-eye training
- I/O pads with impedance calibration logic and data retention capability
- Optional clock gating available for low-power control
- Multiple PLLs for maximum system margin
- Memory controller interface complies with DFI standards 4.0 or 3.1
- Programmable clock delay (PVT compensated) on read and write datapaths for DQS alignment
- Internal and external datapath loop-back modes
- Per-bit deskew on read and write datapath

Benefits

- Lowest-latency for data-intensive applications
- Highest data rates with detailed system guidelines
- Maximum system margin with advanced clocking
Product Details

The DDR PHY IP consists of a DFI interface to the memory controller, external register interface (configuration and test), PHY control block (initialization and calibration logic), and configurable data slices.

The DDR PHY IP is a high-performance DQS-delay architecture that uses programmable clock delay lines to align write data, read data capture, and DQS gating from the I/O pads across the DFI interface to the memory controller.

PHY Architecture

To optimize the DDR interface implementation, the DDR PHY IP provides complete flexibility with process, library, floorplan, I/O pitch, packaging, metal stack up, routing, and other physical parameters.

The DDR PHY IP is implemented with a slice-based architecture that supports a wide range of memory classes and data rates.

Data Slice and Address/Control Slices

The data slice is an 8-bit wide design that interfaces to the DQ, DM, and DQS connections of the DRAM. The data slice is duplicated to create the appropriate data width, allowing flexibility to adjust to meet the data width requirements of the systems or applications.

The Address and Address/Control slices interface to the control, command, and address connections of the DRAM. The Address and Address/Control slice is duplicated to create the appropriate width for different protocols or combination of protocols, allowing flexibility to adjust the number of control, command, and address signals as needed.

External Register Interface

The external register interface is a Cadence-proprietary interface to access the data slice registers.

PHY Control Block

The HS PHY control block provides initialization and calibration logic for training the DQS alignment for each data slice.

Availability

The Cadence IP for DDR PHY IP is available with various configurations and supports the following protocols:

<table>
<thead>
<tr>
<th>Protocol</th>
<th>Speed</th>
<th>Process node</th>
</tr>
</thead>
<tbody>
<tr>
<td>LPDDR4, LPDDR3</td>
<td>HS-3200</td>
<td>TSMC 16FF+</td>
</tr>
<tr>
<td>DDR4, DDR3, DDR3L</td>
<td>HS-3200</td>
<td>TSMC 16FF+</td>
</tr>
<tr>
<td>LPDDR 4/3, DDR4/3/3L</td>
<td>HS-3200</td>
<td>TSMC 16FF+</td>
</tr>
<tr>
<td>LPDDR 4/3, DDR4/3/3L</td>
<td>HS-2400</td>
<td>TSMC 28HPC/HPM</td>
</tr>
</tbody>
</table>

Deliverables

• GDS II macros with abstract in LEF
• Verilog post-layout netlist
• STA scripts for use at chip or standalone PHY levels
• Liberty Timing model
• SDF for back-annotated timing verification
• Verilog models of I/O pads, and RTL for all PHY modules
• Verilog testbench with memory model, configuration files, and sample tests
• Documentation—integration and user guide, release notes
• Verification IP set up files

For more information, visit ip.cadence.com

Related Products

• Cadence Denali Controller IP for LPDDR 4/3/2
• Cadence Denali Controller IP for DDR 4/3/2
• Cadence Verification IP for Memory Models

Cadence Design Systems enables global electronic design innovation and plays an essential role in the creation of today’s electronics. Customers use Cadence software, hardware, IP, and expertise to design and verify today’s mobile, automotive, cloud, and connectivity applications. www.cadence.com

© 2016 Cadence Design Systems, Inc. All rights reserved worldwide. Cadence, the Cadence logo and Denali are registered trademarks of Cadence Design Systems, Inc. in the United States and other countries. All rights reserved. All other trademarks are the property of their respective owners.